

PRODUCT NUMBER
10121021-Y01-02LF

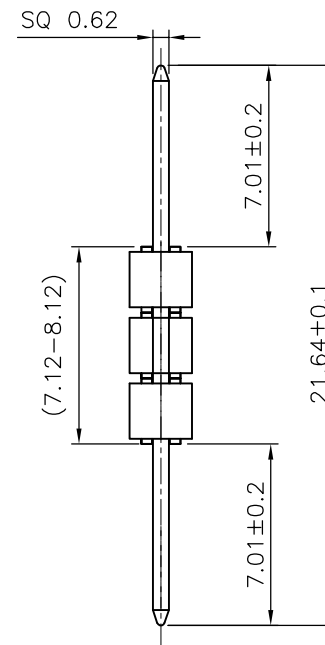
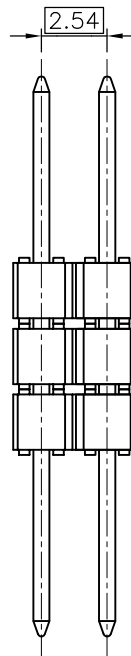
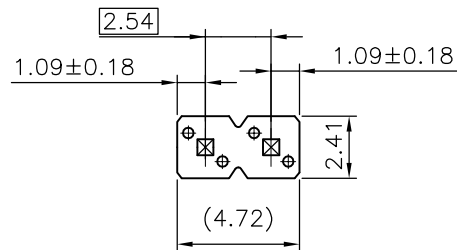
RoHS COMPATIBLE, SEE NOTE 5
NUMBER OF CONTACTS
PIN STYLE

PLATING

4 = 2µm TIN MIN OVER 1.27µm Ni MIN
8 = 0.38µm GOLD/GXT OVER 1.27µm Ni MIN

NOTES:

1. HOUSING MAT'L : HIGH TEMPERATURE THERMOPLASTIC. UL94V-0 COLOR CREAM.
2. PIN MATERIAL : PHOSPHOR BRONZE.
3. 9N MIN RETENTION IN EITHER DIRECTION.
4. STANDARD PACKAGING IN POLYBAG
5. RoHS COMPATIBLE PRODUCT SPECIFICATIONS
 - a - PLATING:
 - "LF" MEANS THE PRODUCT IS LEAD-FREE, 2µm MINIMUM MATTE TIN OVER 1.27µm MINIMUM NICKEL UNDERPLATE.
 - b - MANUFACTURING PROCESS COMPATIBILITY
 - THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.
 - c - LABELING:
 - MEETS PACKAGING SPECS AS PER GS-14-920
 - d - LEGAL STATEMENT: SEE GS-47-0004



mat'l. code		surface		tolerance		projection		product family	
		ISO 1302		ISO 406 ISO 1101				BSTIK	
ltr		ecn no		dr		date		title	
A		F12-0816		LMU		12.10.18		HEADER STR,SR	
B		B-16483		LMU		13.12.10		TRIPLE BODY	
C		B-19562		BVE		14.11.27		dwg no	
D		B-19782		AMA		14.12.16		sheet 1 of 1	
				dr		L MULIN 12.05.09		size	
				enr		A PARRENIN 12.05.09		10121021	
				chr		JCO 12.05.09		A3	
				appd				type	
								CUSTOMER Drawing	
sheet		revision							
index		sheet							